



PATENT APPLICATION
Do. No. 3981-7

Applicant: Joel R. Goergen et al.

Serial No. 10/068,616

Filing Date: February 5, 2002

Group: 2661

**INFORMATION DISCLOSURE CITATION
FORM PTO-1449 (Modified)**

U.S. PATENT DOCUMENTS

Exam <u>Init</u>	<u>Ref</u>	Document <u>Number</u>	Issue <u>Date</u>	Name	Class	Sub- <u>Class</u>
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	—	4,694,123	9/15/87	Massey	—	<u>Technology Center 2600</u>
	—	6,030,693	2/29/00	Boyko	—	—
	—	5,311,406	5/10/94	Snodgrass	—	—
	—	6,229,095	5/8/01	Kobayashi	—	—
	—	5,397,861	3/14/95	Urquhart	—	—
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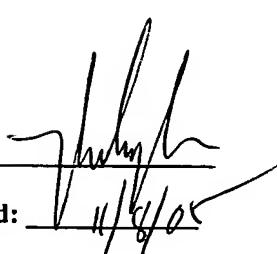
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<u>PL</u>	00 78105	12/21/00	WO	Teradyne Inc.

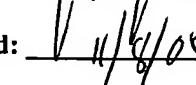
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Examiner: 

Date Considered:  11/6/05



PATENT APPLICATION
Do. No. 3981-7

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Applicant: Joel R. Goergen, Ashby Armistead, and Greg Hunt

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/	—	Teradyne: VHDM Home Page; <u>Backplane Assemblies and Connectors</u> printed on November 6, 2000 from website located at www.teradyne.com/prods/bps/vhdm/intro.html ; pp. 1-3
/	—	Teradyne: Products; <u>Backplanes</u> printed on November 6, 2000 from website located at www.teradyne.com/prods/bps/vhdm/intro.html ; pp. 1-2
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✓ — Cahners EDN Access; New printed-wiring-board materials guard against garbled gigabits printed on November 6, 2000 from website located at www.ednmag.com/ednmag/reg/1999/111199/23ms593.htm; pp. 1-5

✓ — PARKnelco; N4000-6 Overview and product description; pp. 1-2

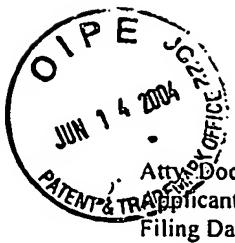
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Examiner: J. Murphy

Date Considered: 11/8/01

**PATENT APPLICATION**

Atty/Docket No.:
Applicant:
Filing Date:

3981-007
Joel R. Goergen, et al.
February 5, 2002

Serial No. 10/068,616
Group: 2661

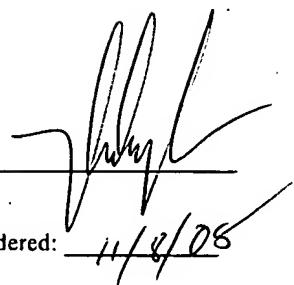
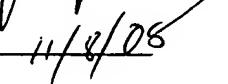
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PATENT APPLICATION

Atty. Docket No.: 3981-007 Serial No. 10/068,616
Applicant: Joel R. Goergen, et al.
Filing Date: February 2, 2003 Group: 2661



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Examiner: J. W. M. H.

Date Considered: 11/8/03

**PATENT APPLICATION**

Asy. Docket No.:
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3981-007
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February 2, 2003

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<u>Init</u>	<u>Number</u>	<u>Date</u>			<u>Class</u>

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<u>JK</u>	<u> </u>	6,630,627	Oct. 7, 2003	Tobita	<u> </u>	<u> </u>

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<u>JK</u>	<u> </u>	JP2001102755	2001-04-13	Japan	Hida, Yoichi

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Examiner: JK

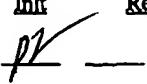
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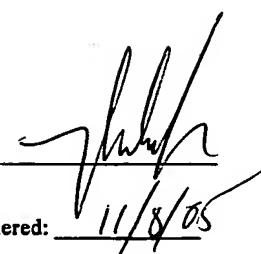
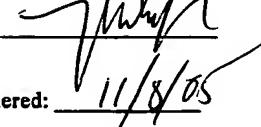
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Date Considered:  11/8/05